

# AEC Electronics Company Limited. PRODUCT SPECIFICATION

## **CERAMIC RESONATOR**

AEC PART NUMBER / SPEC. NO: ZTTCP12MG

**CUSTOMER:** 



Peak soldering temperature 260°C/10 sec
Ceramic component is exempted (According to ROHS directive 2005/95/EC ANNEX point 7)

Customer's Name	
Production Name	Ceramic Resonator
Frequency	12.00MHz
Model No	ZTTCP12MG
Issue Date	23 <sup>rd</sup> April, 2020

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Prepared	Inspection	Approved	
	Andy	Henkie	

Product Specification	<b>Original Date</b>	10/04/2019
1 Todact Specification	PN:	ZTTCP12MG

# 1 SCOPE

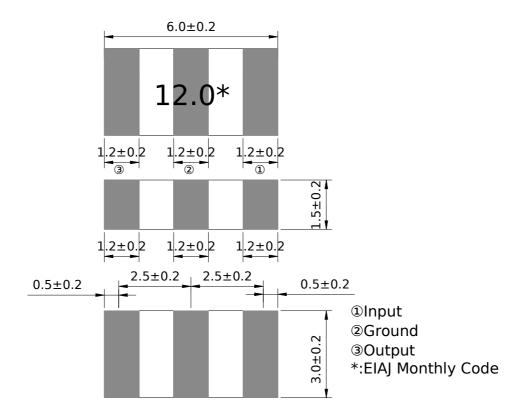
This specification shall cover the characteristics of the ceramic resonator with the type ZTTCP12MG.

# 2 PART NO.

PART NUMBER	
ZTTCP12MG	

# 3. OUTLINE DIMENSIONS AND MARK

- 3.1 Appearance: No visible damage and dirt.
- 3.2 Construction: SMD ceramic packaging.
- 3.3 The products conform to the RoHS directive and national environment protection law.
- 3.4 Dimensions and mark



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#### 4. ELECTRICAL SPECIFICATIONS

#### 4.1 RATING

Items	Requirement
Withstanding Voltage (V)	100 (DC, 5s max)
Insulation Resistance Ri, $(M\Omega)$ min.	500 (10V, 1min)
Operating temperature	-25℃ ~ +85°C
Storage temperature	-55° <b>C ~ +</b> 85° <b>C</b>
Dating Waltage II (W)	6V DC
Rating Voltage $U_R$ (V)	15V p-p AC

#### 4.2 ELECTRICAL SPECIFICATIONS

Items	Requirement	
Oscillation Frequency Fosc (MHz)	12.000	
Frequency Accuracy (%)	<b>±</b> 0.5	
Resonant Impedance Ro $(\Omega)$ max.	30	
Temperature Coefficient of Oscillation	±0.3 (Oscillation Frequency drift,	
Frequency (%) max.	-25°C ~+85°C )	
Oscillation Frequency	±0.1(From initial value)	
Aging Rate (%) max *1	عند المناسطة	

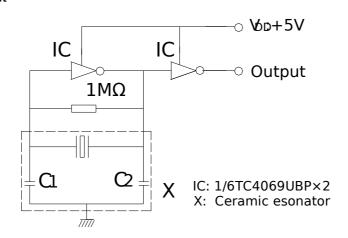
<sup>\*</sup> Components shall be left in a chamber of  $+85\pm2^{\circ}\text{C}$  for 1000 hours, then measured after leaving in natural condition for 1 hours.

#### 5 TEST

#### 5.1 Test Conditions

Parts shall be tested under the condition ( Temp.:  $20\pm15^{\circ}$ C,Humidity :  $65\pm20\%$  R.H.) unless the standard condition(Temp.:  $25\pm3^{\circ}$ C,Humidity :  $65\pm10\%$  R.H.) is regulated to measure.

#### 5.2 Test Circuit



C1 = C2 = 15pF

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# **6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS**

No	Item	Condition of Test		Performance
6.1	Humidity	Keep the resonator at 60°C±2°C and 90%-95% RH for 1000h. Then Release the resonator into the room Condition for 1h prior to the Measurement.		Requirements  It shall fulfill the specifications in Table 1.
6.2	High Temperature Exposure	then release the reso	r to 85°C±2°C for 1000h, onator into the room or to the measurement.	It shall fulfill the specifications in Table 1.
6.3	Low Temperature Exposure	Subject the resonato 1000h, then release room conditions for 1 measurement.	the resonator into the	It shall fulfill the specifications in Table 1.
6.4	Temperature Cycling	After temperature cycling of blow table was performed 5 times, resonator shall be measured after being placed in natural conditions for 1h.  Temperature  -55±3°C  30±3 min  85±3°C  30±3 min		It shall fulfill the specifications in Table 1.
6.5	Vibration	Subject the resonator to vibration for 2h each in x y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.		It shall fulfill the specifications in Table 1.
6.6	Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.		It shall fulfill the specifications in Table 1.
6.7	Soldering Test	Components shall be measured after applying twice of the re-flow soldering with following temperature profile and leaving in natural condition for 1 hour.  Peak:260°Cmax 10s max 250°C 230°C 230°C 250°C 230°C 23		It shall fulfill the specifications in Table 1.

(To be continued)

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### **6 PHYSICAL AND ENVIRONMENAL CHARACTERISICS**

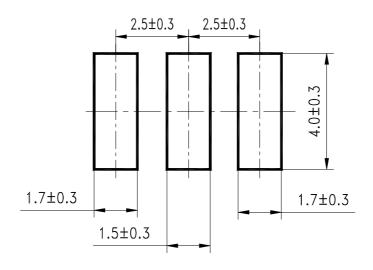
No	Item	Condition of Test	Performance
INO	Item	Colldition of Test	Requirements
6.8	Solder Ability	Dipped in 245°C±5°C solder bath for 3s±0.5 s with rosin flux (25wt% ethanol solution.)	The terminals shall be at least 95% covered by solder.
6.9	Board Bending	Mount a glass-epoxy board (Width=40mm,thickness=1.6mm),then bend it to 1mm displacement and keep it for 5s. (See the following figure)  PRESS  PRESS HEAD  D.U.T.  O  O  Support BAR	Mechanical damage such as breaks shall not occur.

Table 1

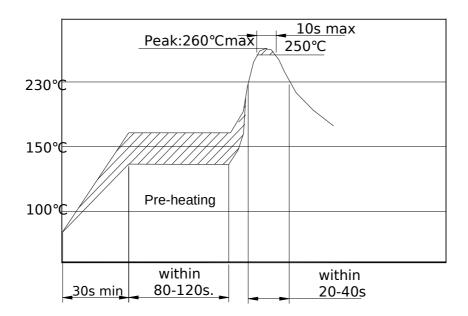
Item	Specification after test	
Oscillation Frequency Change	+0.2	
△ Fosc/Fosc (%) max	±0.2	
Resonant Impedance Ro $(\Omega)$ max.	35	
The limits in the above table are referenced to the initial measurements.		

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# 7 RECOMMENDED LAND PATTERN AND REFLOW SOLDERING STANDARD



# 7.2Recommended Reflow soldering standard conditions



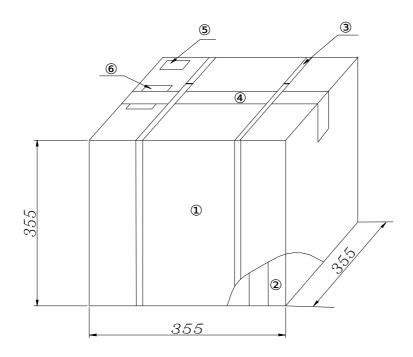
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#### 8. PACKAGE

To protect the products in storage and transportation, it is necessary to pack them (outer and inner package) .

8.1 On paper pack, the following requirements are requested.

#### 8.1.1 Dimensions and Mark



NO.	Name	Quantity
	Package	1
	Inner Box	12
	Belt	2.9 m
	Adhesive tape	1.2 m
	Label	1
	Certificate of approval	1
	Company name ,Address etc.	

### 8.1.2 Section of package

Package is made of corrugated paper with thickness of 0.8cm.Package has 10 inner boxes, each box has 1 reel(each reel for plastic bag)

# 8.1.3 Quantity of package

Per plastic reel 4000 pieces of piezoelectric ceramic part

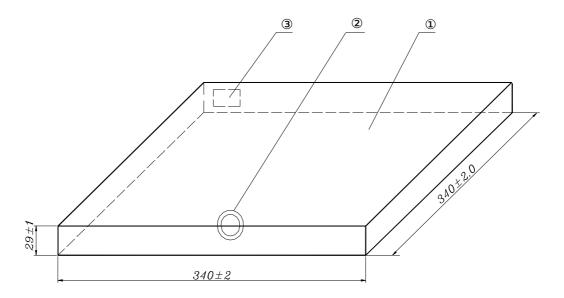
Per inner box 1 reel

Per package 10 inner boxes

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(40000 pieces of piezoelectric ceramic part )

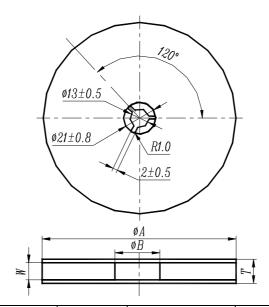
# 8.1.4 Inner Box Dimensions



NO.	Name	Quantity
	Inner Box	1
	QC Label	1
	Label	1

# 8.2 On reel pack, the following requirements are requested.

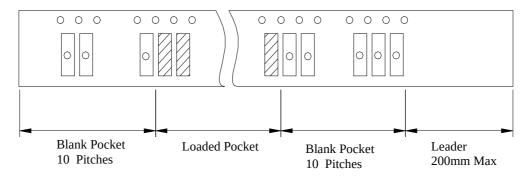
#### 8.2.1 Reel Dimensions



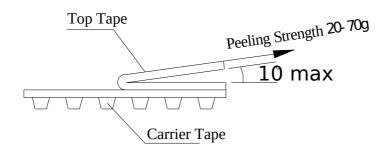
φΑ	φВ	W	T	Pieces per reel	Carrier tape size
330±3	80min	16.4min	22.4max	4000typ.	16

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# 8.2.3 Packing Method Sketch Map



# 8.2.4Test Condition Of Peeling Strength



# 9. EIAJ Monthly Code

2019/2021/2023/2025		2018/2020/2022/2024	
MONTH	CODE	MONTH	CODE
JAN	A	JAN	N
FEB	В	FEB	P
MAR	С	MAR	Q
APR	D	APR	R
MAY	E	MAY	S
JUN	F	JUN	T
JUL	G	JUL	U
AUG	Н	AUG	V
SEP	J	SEP	W
OCT	K	OCT	X
NOV	L	NOV	Y
DEC	M	DEC	Z

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#### 10. OTHER

- 10.1 Caution
- 10.1.1 Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.
- 10.1.2 Do not clean or wash the component for it is not hermetically sealed.
- 10.1.3 Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
- 10.1.4 Don't be close to fire.
- 10.1.5 This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit
- 10.1.6 Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solderability or rusty. Please confirm solderability and characteristics for the products regularly.
- 10.2 Notice
- 10.2.1 Please return one of this specification after your signature of acceptance.
- 10.2.2 When something gets doubtful with this specifications, we shall jointly work to get an agreement.